



# APSEMI

SPST-NO+NC (1 Form A/B) APW614S  
 SOP-8 Load Voltage:400V Load Current:120mA

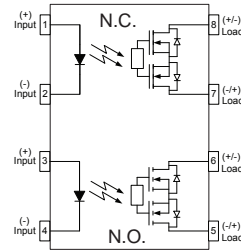


E534710

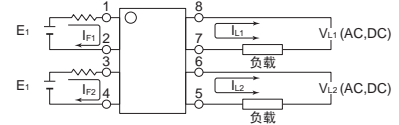
Parameter	Symbol	Rating	Units
Load Voltage	$V_L$	400	V
Load Current	$I_L$	0.12	A
On-Resistance	$R_{on}$	20	$\Omega$
On-Resistance	$V_{io}$	2500	Vrms



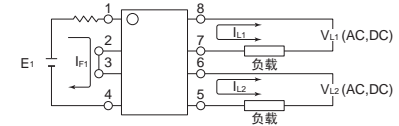
SOP-8



(1) 1a1b 2input



(2) 1a1b 1input



## APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power.

While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical lifetime)
- Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI
- No have voltaic arc, bounce, and noise
- More resistant to vibration and impact
- AC or DC load switching
- Small package size

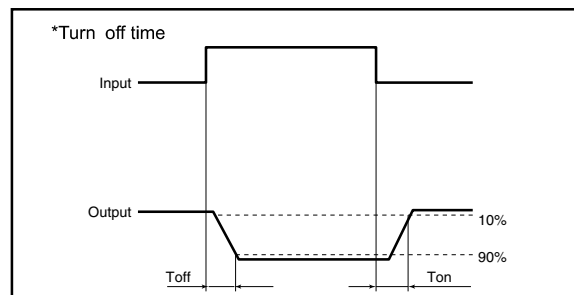
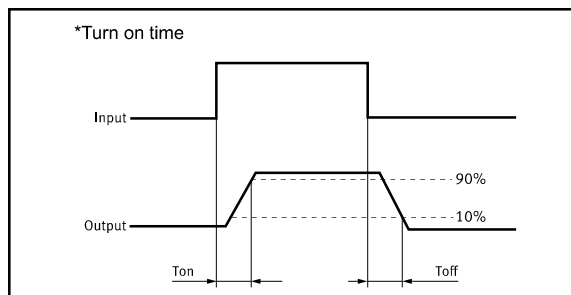
## Applications

These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems
- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

## TPYES

Category	Output Rating		Package	Part No.	Packing Quantity
	Load Voltage	Load Current			
AC/DC	400V	120mA	SOP-8	APW614S	2000pcs /reel



**APSEMI**SPST-NO+NC (1 Form A/B) APW614S  
SOP-8 Load Voltage:400V Load Current:120mA**Absolute Maximum Ratings** (Ta = 25°C)

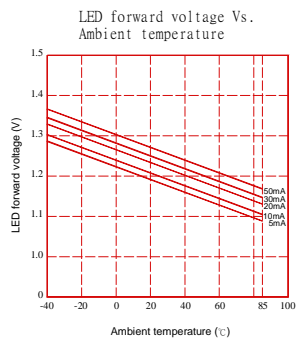
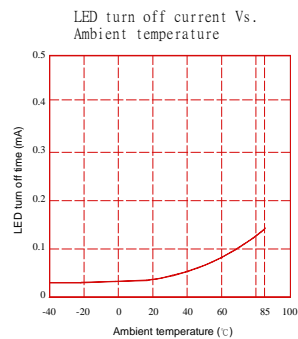
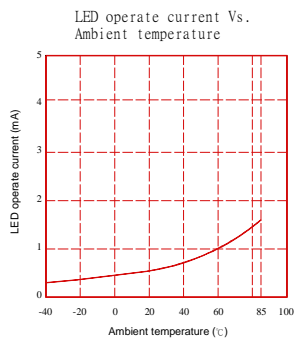
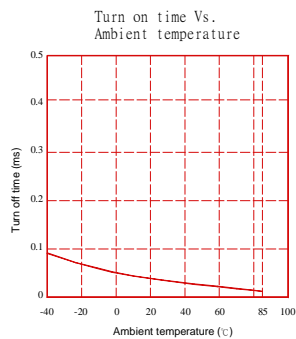
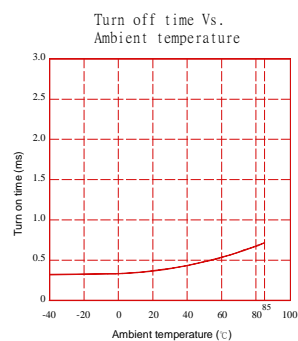
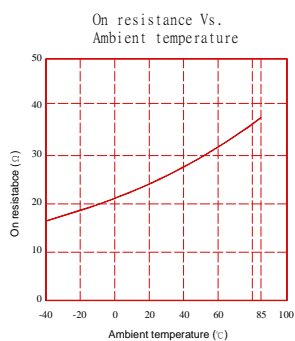
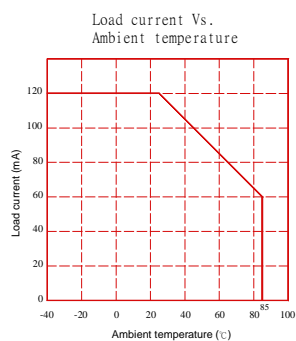
Item		Symbol	Value	Units	Note
Input	Continuous LED Current	IF	50	mA	
	Peak LED Current	IFP	500	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pin	75	mW	
Output	Load Voltage	VL	400	V(AC peak or DC)	
	Load Current	IL	120	mA	
	Peak Load Current	IPeak	0.3	A	1ms(1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Power Dissipation		PT	500	mW	
I/O Breakdown Voltage		VI/O	1500	Vrms	RH=60%, 1min
Operating Temperature		TOpr	-40 to +85	-40 to +85	
Storage Temperature		TStg	-40 to +100	-40 to +100	
Pin Soldering Temperature		TSol	260	260	10 sec max.

**Electrical Characteristics** (Ta = 25°C)

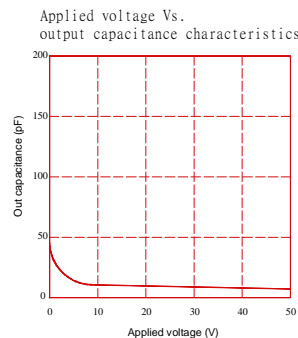
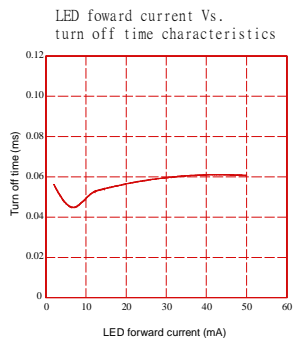
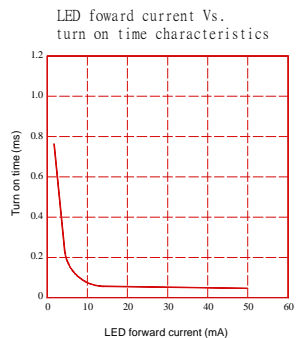
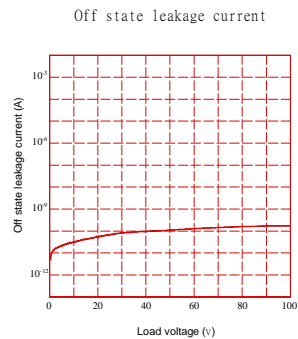
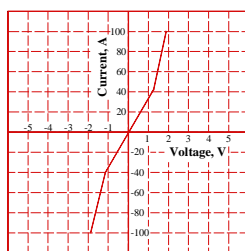
Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	VF		1.2	1.4	V	IF=10mA
	Operation LED Current	IF On		0.5	3.0	mA	
	Recovery LED Current	IF Off		0.35	0.5	mA	
	Recovery LED Voltage	VF Off	0.5			V	
Output	On-Resistance	ROn		20	50	Ω	IF=5mA (N.O.) IF=0mA (N.C) IL=100mA Time to flow is within 1 sec.
	Off-State Leakage Current	ILeak			10	uA	IF=0mA (N.O.) IF=5mA (N.C) VL=400V
	Output Capacitance	COut		165		pF	IF=5mA, VL=0, f=1MHz
Transmis sion	Turn-On Time	TOn		0.23(N.O.)	0.5(N.O.)	ms	IF=5mA, IL=50mA
				0.02(N.C.)	1.0(N.C.)		
	Turn-Off Time	TOff		0.03(N.O.)	0.2(N.O.)	ms	
				0.5(N.C.)	3.0(N.C.)		
Coupled	I/O Isolation Resistance	RI/O	10 <sup>10</sup>			Ω	DC500V
	I/O Capacitance	CI/O		0.8		pF	f=1MHz



## Engineering Data



Voltage Vs. current characteristics of output at MOS portion



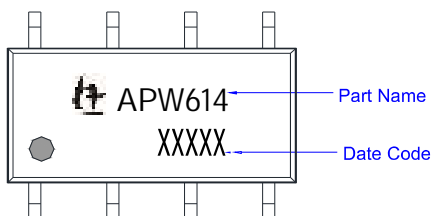


# APSEMI

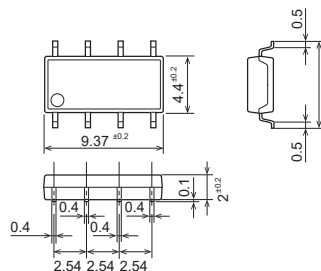
SPST-NO+NC (1 Form A/B) APW614S  
SOP-8 Load Voltage:400V Load Current:120mA

## Dimensions and SOP-8 Package Unit: mm

### Marking



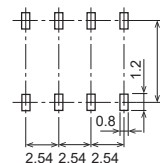
### Surface mount terminal type



### Lable

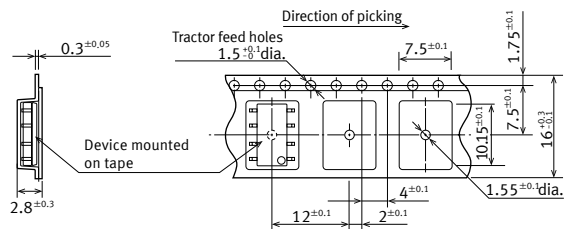


### Recommended mounting pad (Top view)

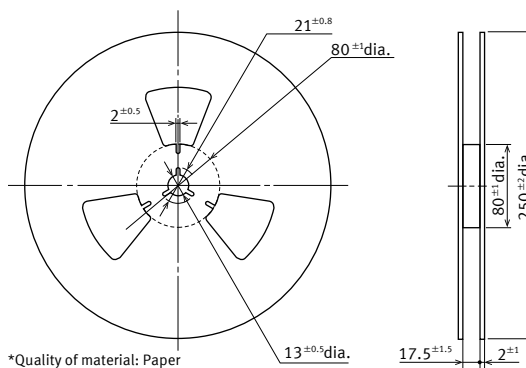


## Tape dimensions ( tape reel )

### Tape dimensions (Unit: mm)



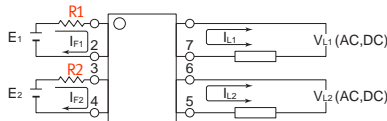
### Dimensions of paper tape reel (Unit: mm)





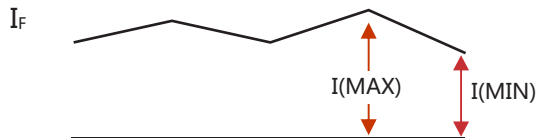
## Using Methods

Examples of resistance value to control LED forward current ( $I_F=5\text{mA}$ )



E1	E2	R1 R2(Approx)
3.3V		300 $\Omega$
5.0V		600 $\Omega$
12V		1.9K $\Omega$
24V		4.1K $\Omega$

LED forward current must be more than 5mA , at  $I(\text{MIN})$  , and less than 30mA , at  $I(\text{MAX})$ .



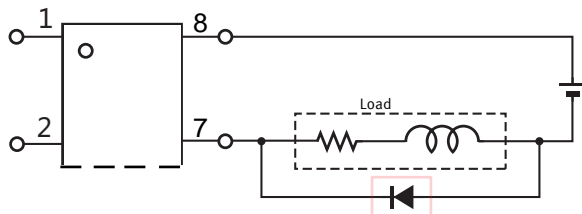
## Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

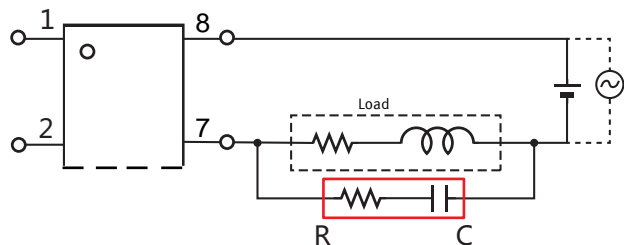
Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	$I_F$	5.0	7.0	30	mA

## Protection Circuit

Clamp diode is connected in parallel with the load.  
Absorb capacity with external diode.



CR Snubber is connected in parallel with the load.  
Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective.  
Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



## RESTRICTIONS ON PRODUCT USE

---

APSEMI Co. and its subsidiaries and affiliates (collectively "APSEMI") reserve the right to make changes to all information contained in this document relating to hardware, software, and systems (collectively "Products").

No information in this document may be reproduced without the prior written permission of APSEMI. Even with APSEMI's written permission, this document may only be reproduced if it is guaranteed to be unaltered or missing.

APSEMI assumes no responsibility for unintended uses of the product:

Unintended uses include, but are not limited to, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, automobiles, trains, ships, and other transportation equipment, traffic signaling equipment, equipment used for the control of combustion or explosions, safety devices, elevators and escalators, equipment used in electrical power-related applications, and equipment used in financial-related applications.

APSEMI assumes no responsibility for the product if you use it for any purpose other than the specific purpose described in this document.

- The information contained herein is provided only as a guide for the use of the product. APSEMI assumes no responsibility for infringement of third party patents or any other intellectual property rights that may result from the use of the product. This document does not grant any license, express or implied, estoppel or otherwise, to any intellectual property.

- GaAs (Gallium Arsenide) is used in products and is harmful to humans. Inadvertent ingestion or absorption of GaAs can harm the human body, so handle the product with care and do not break, cut, crush, grind, chemically dissolve, or otherwise expose GaAs in the product.

- Please be aware of environmental issues and use products in compliance with all applicable laws and regulations governing the inclusion or use of controlled substances, including but not limited to the EU RoHS Directive. APSEMI assumes no responsibility for damages or losses resulting from non-compliance with applicable laws and regulations.